

CRMKTU0209A

N-Channel 20V, 7.5mΩ Typ. Power MOSFET

Description

Features

• 20V, 40A

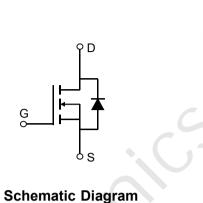
 $R_{DS(ON)}$ Typ = 7.5m Ω @ V_{GS} = 4.5V

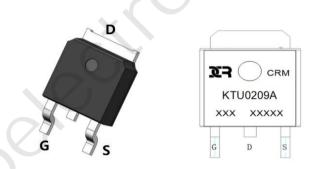
 $R_{DS(ON)}$ Typ = 10.5m Ω @ V_{GS} = 2.5V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTU0209A	CRMKTU0209A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		20	V
V _{GS}	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T _C = 25°C	40	А
Ι _D	Continuous Drain Current	T _C = 100°C	24	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		160	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		30	mJ
P _D	Power Dissipation	T _C = 25°C	27	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		4.6	°C/W
T _J , T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	I _D = 250μΑ, V _{GS} = 0V	20	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Chara	acteristics				G	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	0.4	0.7	1	V
_	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 15A	-	7.5	9.8	mΩ
$R_{DS(ON)}$		V _{GS} = 2.5V, I _D = 10A	-	10.5	13.5	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	1055	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 10V, f = 1MHz	Χ-	160	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 110112		140	-	pF
Q _g	Total Gate Charge	0	<u> </u>	13	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 4.5V $V_{DS} = 10V$, $I_{D} = 15A$	-	2.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	v _{DS} = 100, 10 = 10A	-	3.5	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	8	-	ns
t _r	Turn-On Rise Time	V _{GS} = 4.5V, V _{DD} = 10V	-	19	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 15A, R_{GEN} = 3 Ω	-	30	-	ns
t _f	Turn-Off Fall Time		-	11	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	40	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	160	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 15A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	7.5	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	1.5	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

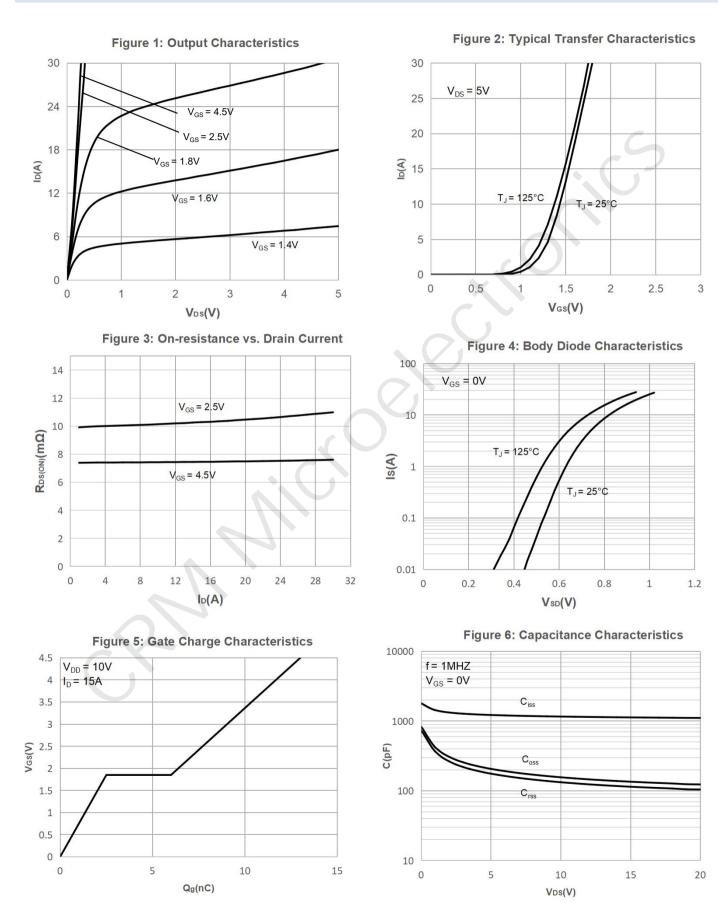
2. E_{AS} condition: Starting T_J=25°C, V_{DD}=10V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=11A

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.



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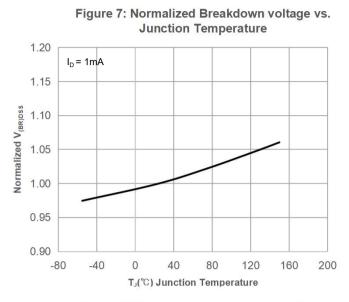
Typical Performance Characteristics





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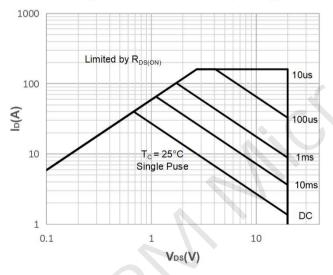
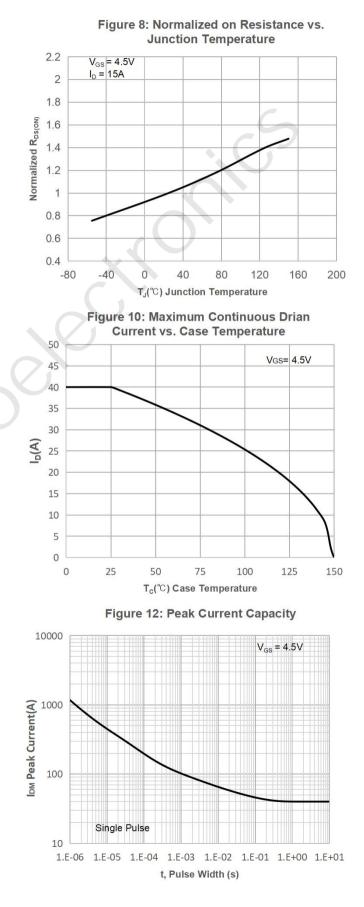


Figure 11: Normalized Maximum Transient Thermal Impedance 10 D = 0.502 Normalized Thermal Impedance, Z_{8JC} 0.1 0.05 0.02 1 0.01 0.1 0.01 Duty factor: D = t1/t2 TI = TC + PDM X ZAIC Rein 0.001 1.E-06 1.E-05 1.E-04 1.E-03 1.E+00 1.E+01 1.E-02 1.E-01 t, Pulse Width (s)





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Test Circuit

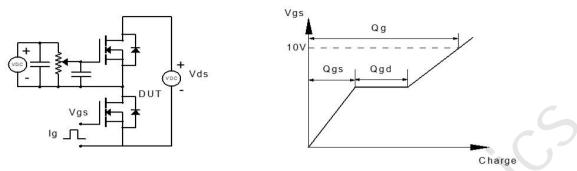


Figure 1: Gate Charge Test Circuit & Waveform

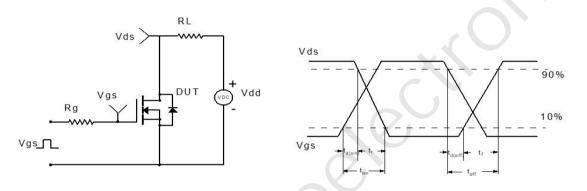
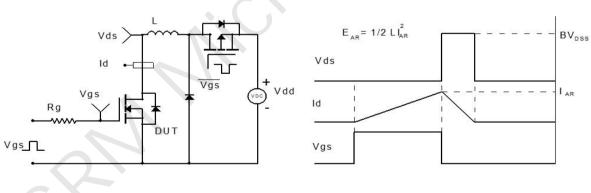


Figure 2: Resistive Switching Test Circuit & Waveform





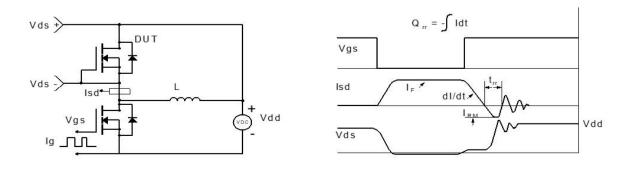
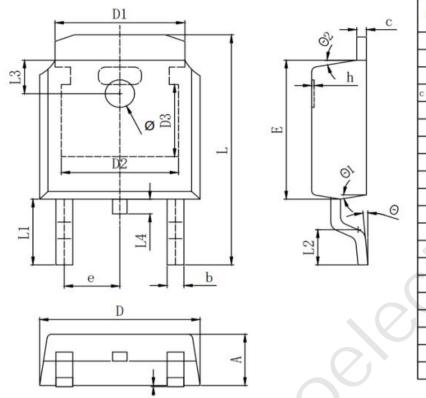


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
SIMBOL	MIN	Typ.	MAX		
A	2.200	2.300	2.400		
Al	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6.700		
D1	5.334 REF				
D2	4.826 REF				
D3	3.166 REF				
E	6.000	6.100	6.200		
e	2.286 TYP				
h	0.000	0.100	0.200		
L	9.900	10.100	10.300		
L1	2.888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
ф	1.100	1.200	1.300		
θ	0°		8°		
θ 1	9° TYP				
02	9° TYP				

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